

# DATA SHEET

## SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade Array

NPO/X7R |6 V TO 50 V sizes 0508 (4 x 0402) / 0612 (4 x 0603)

RoHS compliant & Halogen Free



## YAGEO

#### YAGEO

Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### <u>SCOPE</u>

This specification describes Automotive grade NP0/X7R series chip capacitors with lead-free terminations and used for automotive equipments.

#### **APPLICATIONS**

- Professional electronics
- High density consumer electronics

#### FEATURES

- AEC-Q200 qualified
- MSL class: MSL I
- AC series soldering is compliant with J-STD-020D
- 0508 (4x0402) / 0612 (4x0603) capacitors (of the same capacitance value) per array
- Less than 50% board space of an equivalent discrete component
- Increased throughout, by time saved in mounting
- RoHS compliant & Halogen free
- The capacitors are 100% performed by automatic optical inspection prior to taping.

#### ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

#### YAGEO BRAND ordering code GLOBAL PART NUMBER (PREFERRED)

#### AC <u>xxxx</u> <u>x</u> <u>x</u> <u>xxx</u> <u>x</u> B <u>x</u> <u>xxx</u> (1) (2) (3) (4) (5) (6) (7)

#### (I) SIZE - INCH BASED (METRIC)

0508 (1220) 0612 (1632)

#### (2) TOLERANCE

- J = ±5%
- $K = \pm 10\%$
- $M = \pm 20\%$

#### (3) PACKING STYLE

- R = Paper/PE taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch

#### (4) TC MATERIAL

NPO

X7R

#### (5) RATED VOLTAGE

 $7 = 16 \vee 8 = 25 \vee$ 

#### 9 = 50 V

#### (6) PROCESS

N = NP0B = class 2 material, X7R

#### (7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

Example:  $|2| = |2 \times |0| = |20 \text{ pF}$ 



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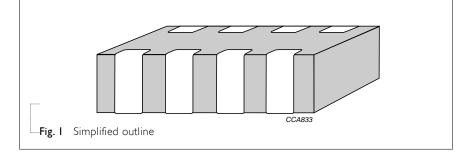
Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### **CONSTRUCTION**

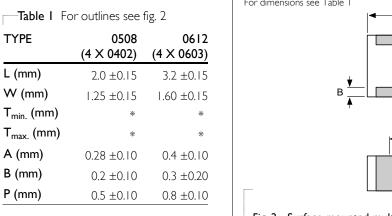
The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn).

The terminations are lead-free. An outline of the structure is shown in Fig. I.

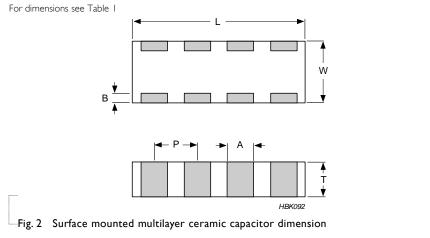


#### OUTLINES



#### ΝΟΤΕ

\* Refer to Table 2 ~Table 3





<u>CAPACITANCE</u>	RANGE	સ	THICKNESS	FOR	4C-ARRAY

-Table 2 Temperature characteristic material from NP0

CAPACITANCE	0508 (4 × 0402) 50 ∨	0612 (4 × 0603)
		50 V
10 pF	0.6±0.1	0.8±0.1
I5 pF	0.6±0.1	0.8±0.1
18 pF	0.6±0.1	0.8±0.1
22 pF	0.6±0.1	0.8±0.1
33 pF	0.6±0.1	0.8±0.1
39 pF	0.6±0.1	0.8±0.1
47 pF	0.6±0.1	0.8±0.1
56 pF	0.6±0.1	0.8±0.1
68 pF	0.6±0.1	0.8±0.1
82 pF	0.6±0.1	0.8±0.1
100 pF	0.6±0.1	0.8±0.1
120 pF		0.8±0.1
150 pF		0.8±0.1
180 pF		0.8±0.1
220 pF		0.8±0.1
270 pF		0.8±0.1
330 pF		0.8±0.1
390 pF		0.8±0.1
470 pF		0.8±0.1
560 pF		
680 pF		
820 pF		
I.0 nF		

#### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm



#### CAPACITANCE RANGE & THICKNESS FOR 4C-ARRAY

Table 3 Temperature characteristic material from X7R

CAPACITANCE	0508 (4 × 0402)			0612 (4×0603)		
	16 V	25 V	50 V	16 V	25 V	50 V
I.0 nF	0.6±0.1	0.6±0.1	0.6±0.1	0.8±0.1	0.8±0.1	0.8±0.1
I.5 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
2.2 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
3.3 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
4.7 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
6.8 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
10 nF	0.6±0.1	0.6±0.1		0.8±0.1	0.8±0.1	0.8±0.1
22 nF	0.6±0.1					
47 nF	0.6±0.1			0.8±0.1	0.8±0.1	
100 nF	0.6±0.1					

#### ΝΟΤΕ

Values in shaded cells indicate thickness class in mm

Jul. 09, 2021 V.0

#### THICKNESS CLASSES AND PACKING QUANTITY

Table 4							
SIZE	THICKNESS		Ø180	MM / 7 INCH	Ø330 MM / 13 INCH		
CODE	CLASSIFICATION	QUANTITY PER REEL	Paper	Blister	Paper	Blister	
0508	0.6 ±0.1 mm	8 mm	4,000		20,000		
0612	0.8 ±0.1 mm	8 mm	4,000		15,000		

#### ELECTRICAL CHARACTERISTICS

#### NP0/X7R DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 5		
DESCRIPTION		VALUE
Capacitance range		10 pF to 100 nF
Capacitance tolerance		
NP0	C ≥ 10 pF	±5%
X7R		±10%, ±20%
Dissipation factor (D.F	.)	
NP0	C < 30 <sub>P</sub> F	≤   / ( 400 + 20C )
	C ≥ 30 <sub>P</sub> F	≤ 0.1%

X7R	0508 (Array)	0612 (Array)	
16V	InF to IOnF	220pF to 47nF	≤ 3.5%
	I5nF to I00nF		≤ 5%
25V	InF to IOnF	220pF to 47nF	≤ 2.5%
50V	InF	220pF to 10nF	≤ 2.5%
Insulation resist	ance after I minute  at  U <sub>r</sub> (DC)	IR ≥ 10G $\Omega$ or 1.R x C ≥ 500 second	ls whichever is less

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Surface-Mount Ceramic Multilayer Capacitors Automotive Array NP0/X7R 16 V to 50 V

#### SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds ٠
- ٠ Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

#### TESTS AND REQUIREMENTS

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS				
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage				
Capacitance	IEC 60384- 21/22	4.5.1	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for C $\leq$ InF, measuring at voltage 1 V <sub>rms</sub> at 20 °C f = 1 KHz for C > InF, measuring at voltage 1 V <sub>rms</sub> at 20 °C Class 2: At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20 °C	Within specified tolerance				
Dissipation Factor (D.F.)	IEC 60384- 21/22	4.5.2	Class I: At 20 °C, 24 hours after annealing $f = 1$ MHz for $C \le InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C f = 1 KHz for $C > InF$ , measuring at voltage 1 V <sub>rms</sub> at 20 °C Class 2: At 20 °C, 24 hours after annealing f = 1 KHz, measuring at voltage 1 V <sub>rms</sub> at 20 °C	In accordance with specification				
Insulation Resistance	IEC 60384- 21/22	4.5.3	At $U_r$ (DC) for 1 minute	In accordance with specification				
High Temperature Exposure	AEC-Q200	3	Unpowered ; 1000hours @ T=150° <b>C</b> Measurement at 24±2 hours after test conclusion.	No visual damage $\Delta C/C$ : Class1: NP0: within ±0.5% or 0.5 pF whichever is greater Class2: X7R: ±10% D.F.: within initial specified value IR: within initial specified value				

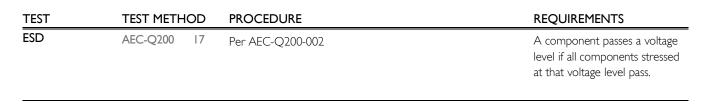


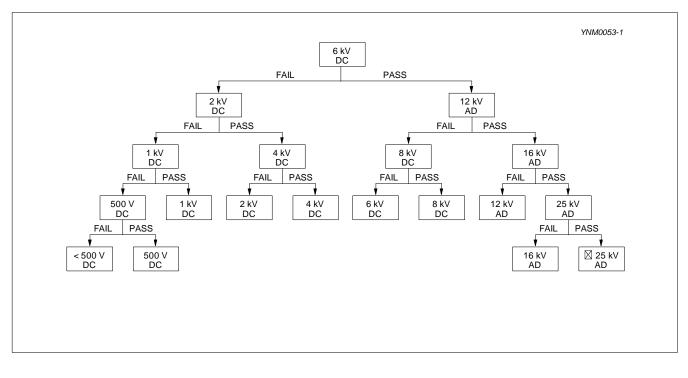
TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS				
Temperature Cycling	AEC-Q200	4	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for	No visual damage				
	24 ±1 hours at room temperature 1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature Recovery time 24 ±2 hours		1000 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature	$\Delta$ C/C Class I: NP0: Within ±1% or 0.5pF, whichever is greater. Class2: X7R: ±10%				
				D.F. meet initial specified value IR meet initial specified value				
Destructive Physical Analysis	AEC-Q200	5	Note: Only applies to SMD ceramics. Electrical test not required.					
Moisture Resistance	AEC-Q200	6	T=24 hrs/per cycle; 10 continuous cycles unpowered. Measurement at 24 ±2 hours after test condition.	No visual damage				
				$\Delta$ C/C NP0: Within ±3% or 3 pF, whichever is greater X7R: ±15%				
				D.F. Within initial specified value IR NP0: $\geq$ 10,000 M $\Omega$ X7R: Meet initial specified value				

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.4 Moisture resistant																															

TEST	EST TEST METHOD PROCEDURE							
Biased Humidity	AEC-Q200	7	I. Preconditioning, class 2 only: I50 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp	No visual damage after recovery				
			<ol> <li>Initial measure: Parameter: IR Measuring voltage: 1.5V ± 0.1 VDC Note: Series with 100 KΩ</li> <li>Test condition: 85 °C, 85% R.H. connected with 100 KΩ resistor, applied 1.5V/U<sub>r</sub> for 1,000 hours.</li> <li>Recovery: Class1: 6 to 24 hours Class2: 24 ±2 hours</li> <li>Final measure: IR</li> </ol>	Initial requirement: Class I: - Connected to 100 K $\Omega$ : C $\leq$ 10 nF: I.R $\geq$ 10,000 M $\Omega$ or C $>$ 10 nF: (I.R-100 K $\Omega$ ) $\times$ C $\geq$ 100s. Class2: - Connected to 100 K $\Omega$ : C $\leq$ 25 nF: I.R $\geq$ 4,000 M $\Omega$ or C $>$ 25 nF: (I.R-100 K $\Omega$ ) $\times$ C $\geq$ 100s. Final measurement: The insulation resistance shall be greater than 0.1 time initial value.				
Operational Life	AEC-Q200	8	I. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for	No visual damage				
			<ul> <li>24 ±1 hour at room temp</li> <li>2. Initial measure: Spec: refer to initial spec C, D, IR</li> <li>3. Endurance test:</li> </ul>	$\Delta$ C/C NP0: Within ±2% or 1 pF, whichever is greater X7R: ±15%				
			Temperature: X7R: 125 °C	D.F.				
			<ul> <li>Specified stress voltage applied for 1,000 hours: Applied 2.0 × U<sub>r</sub> s</li> <li>4. Recovery time: 24 ±2 hours</li> </ul>	NP0: $\leq 2 \times$ specified value. X7R: $\leq 16V$ : $\leq 7\%$ or specified value whichever is greater				
			5. Final measure: C, D, IR	$\geq$ 25V: $\leq$ 5% or specified value whichever is greater				
			Note: If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to <i>'IEC 60384 4.1"</i> and then the requirement shall be met.	IR NP0: ≥ 4,000 M $\Omega$ or IR × C <sub>r</sub> ≥ 40s whichever is less X7R: ≥ 1,000 M $\Omega$ or IR× C <sub>r</sub> ≥ 50s whichever is less				
External Visual	AEC-Q200	9	Any applicable method using × 10 magnification	In accordance with specification				
Physical Dimension	AEC-Q200	10	Verify physical dimensions to the applicable device specification.	In accordance with specification				

TEST								
Mechanical Shock	AEC-Q200	13	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	$\label{eq:constraint} \begin{array}{l} \Delta C/C \\ \text{NP0: Within } \pm 0.5\% \text{ or } 0.5 \text{ pF,} \\ \text{whichever is greater} \\ \times 7 \text{R: } \pm 10\% \\ \end{array} \\ \begin{array}{l} \text{D.F.} \\ \text{Within initial specified value} \\ \text{IR} \\ \text{Within initial specified value} \end{array}$				
Vibration	AEC-Q200	14	5 g's for 20 minutes, 12 cycles each of 3 orientations.	$\Delta$ C/C NP0: Within ±0.5% or 0.5 pF, whichever is greater X7R: ±10%				
				D.F: meet initial specified value IR meet initial specified value				
Resistance to Soldering Heat	AEC-Q200	15	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature Preheating: 120 °C to 150 °C for 1 minute Solder bath temperature: 260 ±5 °C	Dissolution of the end face plating shall not exceed 25% o the length of the edge concerned				
			Dipping time: 10 ±0.5 seconds Recovery time: 24 ±2 hours	$\Delta$ C/C Class1: NP0: Within ±1% or 0.5 pF, whichever is greater. Class2: X7R: ±10%				
				D.F. within initial specified value IR within initial specified value				
Thermal Shock	AEC-Q200	16	<ol> <li>Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room a temp</li> <li>Initial measure: Spec: refer to initial spec C, D, IR</li> <li>Rapid change of temperature test: NP0/X7R: -55 °C to +125 °C; 300 cycles 15 minutes at lower category temperature; 15 minutes at upper category temperature.</li> <li>Recovery time: Class1: 6 to 24 hours</li> </ol>	No visual damage $\Delta C/C$ NP0: Within ± 1% or 1 pF, whichever is greater X7R: ±15% D.F: meet initial specified value IR meet initial specified value				
			4. Recovery time:					





Solderability	AEC-Q200	18	<ol> <li>Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.</li> </ol>	The solder should cover over 95% of the critical area of each termination.
			<ol> <li>Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C.</li> </ol>	
			3. Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 120±5 seconds at 260±5°C.	

Product specification 11

TEST	TEST METHOD		PROCEDURE	AC/C         Class 1:         NP0: ±30 ppm/°C         Class2:         X7R: ±15%	
Electrical Characterization	AEC-Q200 19		Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max operating temperatures. Class 1: NP0: -55 °C to +125 °C Normal temperature: 20 °C Class 2: X7R: -55 °C to +125 °C Normal temperature: 20 °C		
Board Flex	AEC-Q200	21	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick Part should be mounted using the following soldering reflow profile. Conditions: Class I: Bending 3 mm at a rate of 1 mm/s, radius jig 340 mm Class2: Bending 2 mm at a rate of 1 mm/s, radius jig 340 mm	No visible damage ΔC/C Class I: NP0: Within ±1% or 0.5 pF, whichever is greater Class2: X7R: ±10%	
Terminal Strength	AEC-Q200	22	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.	Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before and after the test, the device shall comply with all electrical requirements stated in this specification.	
Beam Load Test	AEC-Q200	23	Place the part in the beam load fixture. Apply a force until the part breaks or the minimum acceptable force level required in the user specification(s) is attained.	0508: 20N 0612: 15N	
Voltage Proof			1. Specified stress voltage applied for $1 \sim 5$ seconds 2. Ur $\leq 100$ V: applied 2.5 Ur	No breakdown or flashover	
			Charge/Discharge current is less than 50 mA		

#### <u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	July 09, 202 I	-	- New Datasheet

#### Surface-Mount Ceramic Multilayer Capacitors

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